



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

Salman Akram

Serial No.: 09/853,111

Filed: May 10, 2001

For: Method of Fabricating Mounted
Multiple Semiconductor Dies
In a Package (As Amended)

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Art Unit: 2827

Examiner: Alonzo Chambliss

Atty Docket: MCT.0012D1US
97-0141.02

Mail Stop **RCE**
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Prior to receipt of an office action in the continuing application, please amend the above-referenced patent application as follows: